



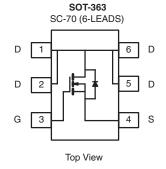
N-Channel 30 V (D-S) MOSFET

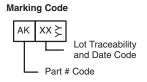
PRODUCT SUMMARY					
V _{DS} (V)	$R_{DS(on)}(\Omega)$	I _D (A)	Q _g (Typ.)		
30	0.066 at $V_{GS} = 4.5 \text{ V}$	4.0 ^a	4.85		
	0.095 at V _{GS} = 2.5 V	4.0	4.65		

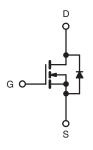
FEATURES

- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET[®] Power MOSFET
- 100 % R_q and UIS Tested
- Compliant to RoHS Directive 2002/95/EC









Ordering Information: Si1470DH-T1-E3 (Lead (Pb)-free)

Si1470DH-T1-GE3 (Lead (Pb)-free and Halogen-free)

N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS	T _A = 25 °C, unl	ess otherwis	se noted		
Parameter	Symbol	Limit	Unit		
Drain-Source Voltage		V _{DS}	30	V	
Gate-Source Voltage		V _{GS}	± 12	7 '	
	T _C = 25 °C		5.1		
Continuous Drain Current /T = 150 °C\8	T _C = 70 °C	I _D	4.0		
Continuous Drain Current (T _J = 150 °C) ^a	T _A = 25 °C		3.8 ^{b, c}	A	
	T _A = 70 °C		3.1 ^{b, c}		
Pulsed Drain Current		I _{DM}	12		
Avalanche Current		I _{AS}	10		
Repetitive Avalanche Energy L = 0.1 mH		E _{AS}	5	mJ	
Continuous Source-Drain Diode Current	T _C = 25 °C		2.3	А	
Continuous Source-Diam Diode Current	T _A = 25 °C	l _S	1.3 ^{b, c}	Π ^	
	T _C = 25 °C		2.8		
Maximum Power Dissipation ^a	T _C = 70 °C	<u> </u>	1.8	w	
	T _A = 25 °C	P _D	1.5 ^{b, c}	vv	
	T _A = 70 °C		1.0 ^{b, c}		
Operating Junction and Storage Temperature Ra	T _J , T _{stg}	- 55 to 150	°C		

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient ^{b, d}	t ≤ 5 s	R_{thJA}	60	80	°C/W	
Maximum Junction-to-Foot (Drain)	Steady State	R _{thJF}	34	45	C/VV	

Notes:

- a. Based on $T_C = 25$ °C.
- b. Surface mounted on 1" x 1" FR4 board.
- c. t = 5 s.
- d. Maximum under steady state conditions is 125 $^{\circ}\text{C/W}.$



Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V_{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	30			V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	J 050 · · A		27.41		mV/°C	
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}$	$I_D = 250 \mu A$		- 3.83			
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	0.6		1.6	V	
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 12 \text{ V}$			± 100	nA	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 30 V, V _{GS} = 0 V			1	nA	
		$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 85 ^{\circ}\text{C}$			10	μΑ	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} = \ge 5 \text{ V}, V_{GS} = 4.5 \text{ V}$	12			Α	
Drain-Source On-State Resistance ^a		$V_{GS} = 4.5 \text{ V}, I_D = 3.8 \text{ A}$		0.055	0.066		
	R _{DS(on)}	V _{GS} = 2.5 V, I _D = 3.1 A		0.079	0.095	Ω	
Forward Transconductance	9 _{fs}	V _{DS} = 15 V, I _D = 3.8 A		11.2		S	
Dynamic ^b		-		I	l	ı	
Input Capacitance	C _{iss}			510		pF	
Output Capacitance	C _{oss}	V _{DS} = 15 V, V _{GS} = 0 V, f = 1 MHz		66			
Reverse Transfer Capacitance	C _{rss}			39			
	Qg	$V_{DS} = 15 \text{ V}, V_{GS} = 5 \text{ V}, I_D = 3.8 \text{ A}$		5	7.5		
Total Gate Charge		V _{DS} = 15 V, V _{GS} = 4.5 V, I _D = 3.8 A		4.85	7.3	nC	
Gate-Source Charge	Q _{gs}			1.35			
Gate-Drain Charge	Q _{qd}			1.26			
Gate Resistance	R_{g}	f = 1 MHz		7.3	10.95	Ω	
Turn-On Delay Time	t _{d(on)}			9.0	15		
Rise Time	t _r	$V_{DD} = 15 \text{ V}, R_1 = 5.0 \Omega$		51	77	ns	
Turn-Off DelayTime	t _{d(off)}	$I_D \cong 3.0 \text{ A}, V_{GEN} = 4.5 \text{ V}, R_g = 1 \Omega$		18	27		
Fall Time	t _f			7.1	10.65		
Drain-Source Body Diode Characteristic	cs						
Continous Source-Drain Diode Current	I _S	T _C = 25 °C			2.3	A	
Pulse Diode Forward Current ^a	I _{SM}				12		
Body Diode Voltage	V _{SD}	I _S = 1.8 A		0.8	1.2	V	
Body Diode Reverse Recovery Time	t _{rr}	-		11.5	17.25	nC	
Body Diode Reverse Recovery Charge	Q _{rr}			5.2	7.8		
Reverse Recovery Fall Time	t _a	I _F = 2.3 A, dl/dt = 100 A/μs		7.7		ns	
Reverse Recovery Rise Time	t _b			3.8			

Notes:

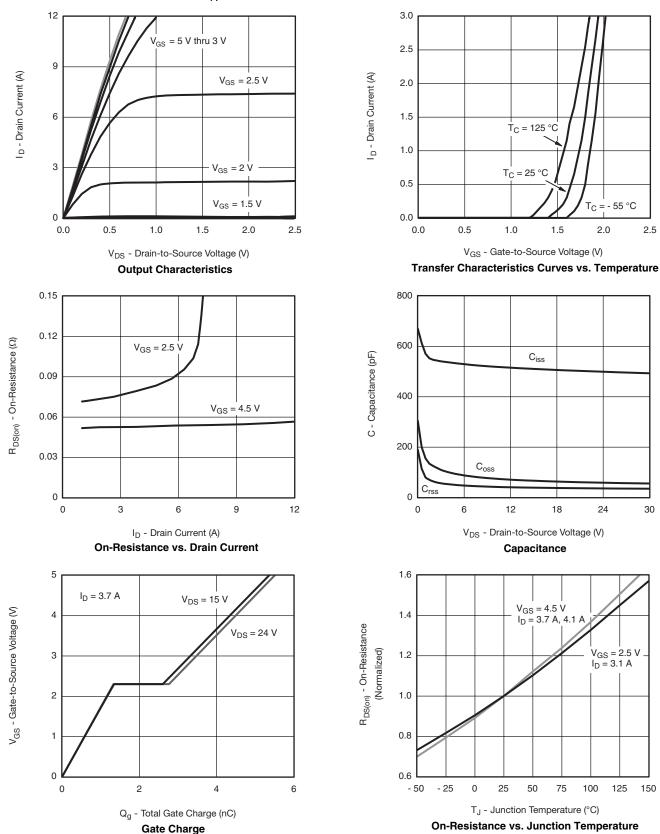
- a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



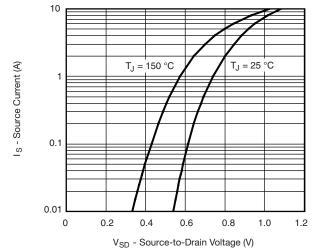


TYPICAL CHARACTERISTICS $T_A = 25$ °C, unless otherwise noted

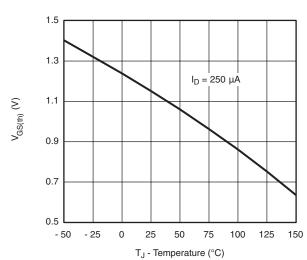


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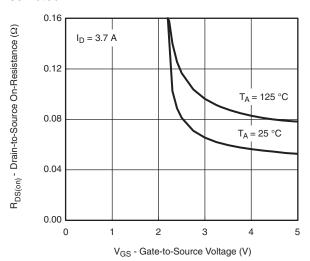
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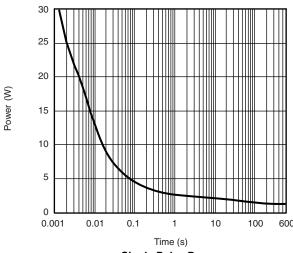
Source-Drain Diode Forward Voltage



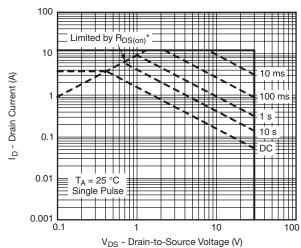
Threshold Voltage



R_{DS(on)} vs. V_{GS} vs. Temperature



Single Pulse Power

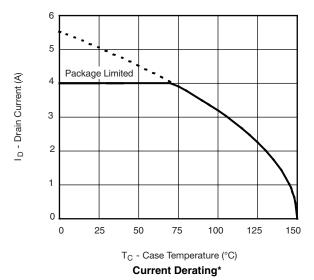


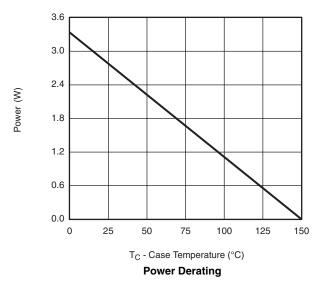
 * V $_{GS}$ > minimum V $_{GS}$ at which R $_{DS(on)}$ is specified

Safe Operating Area, Junction-to-Ambient



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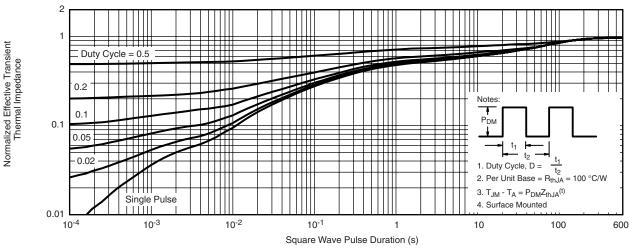




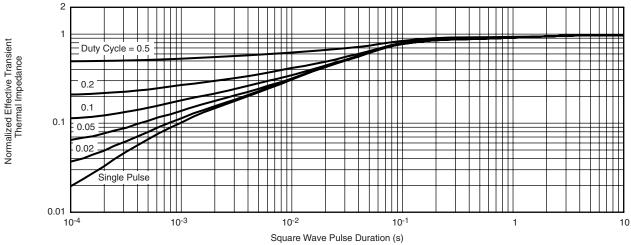
^{*} The power dissipation P_D is based on $T_{J(max)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit

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TYPICAL CHARACTERISTICS $T_A = 25 \, ^{\circ}C$, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

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